

MGFC45V5964A

5.9 - 6.4GHz BAND 32W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC45V5964A is an internally impedance matched GaAs power FET especially designed for use in 5.9 - 6.4 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

- Internally matched to 50 ohm system
- High output power
P1dB = 32W (TYP.) @ f=5.9 - 6.4 GHz
- High power gain
GLP =9.0 dB (TYP.) @ f=5.9 - 6.4 GHz
- High power added efficiency
P.A.E. = 33 % (TYP.) @ f=5.9 - 6.4 GHz
- Low Distortion[Item-51]
IM3=-45 dBc(TYP.)@Po=34.5dBm S.C.L.

APPLICATION

5.9 - 6.4 GHz band power amplifier

QUALITY GRADE

IG

RECOMMENDED BIAS CONDITIONS

- VDS = 10 (V)
- ID = 8 (A)
- Rg=25 (ohm) Refer to Bias Procedure

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain voltage	-15	V
VGSO	Gate to source voltage	-15	V
ID	Drain current	25	A
IGR	Reverse gate current	-80	mA
IGF	Forward gate current	168	mA
PT	Total power dissipation	150	W
Tch	Channel temperature	175	deg.C
Tstg	Storage temperature	-65 / +175	deg.C

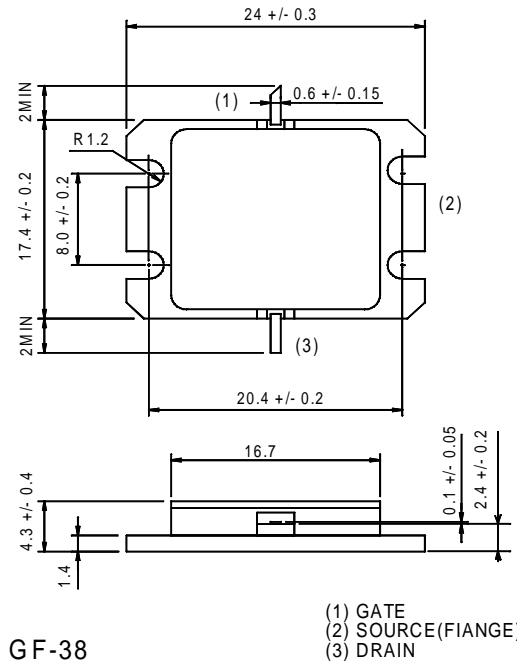
*1 : Tc=25 Deg.C

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
IDSS	Saturated drain current	VDS = 3V , VGS = 0V	-	24	-	A
Gm	Transconductance	VDS = 3V , ID = 8A	-	8	-	S
VGS(off)	Gate to source cut-off voltage	VDS = 3V , ID = 160mA	-2	-	-5	V
P1dB	Output power at 1dB gain compression	VDS=10V, ID(RF off)=8A, f=5.9-6.4GHz	44	45	-	dBm
GLP	Linear power gain		8	9	-	dB
PAE	Power added efficiency		-	33	-	%
IM3	3rd order IM distortion *1		-42	-45	-	dBc
Rth(ch-c)	Thermal resistance *2	Delta Vf method	-	0.8	1.0	Deg.C/W

*1 : item -51, 2 tone test, Po=34.5dBm Single Carrier Level, f=6.4GHz, Delta f=10MHz *2 : Channel-case

OUTLINE DRAWING Unit:millimeters (inches)



GF-38

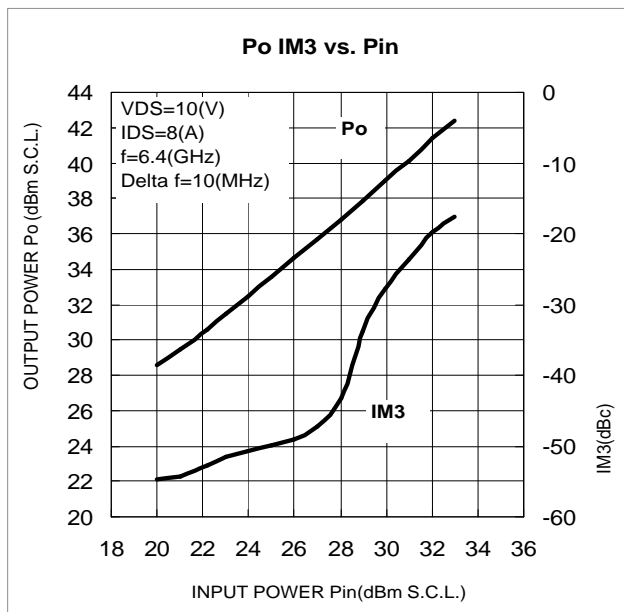
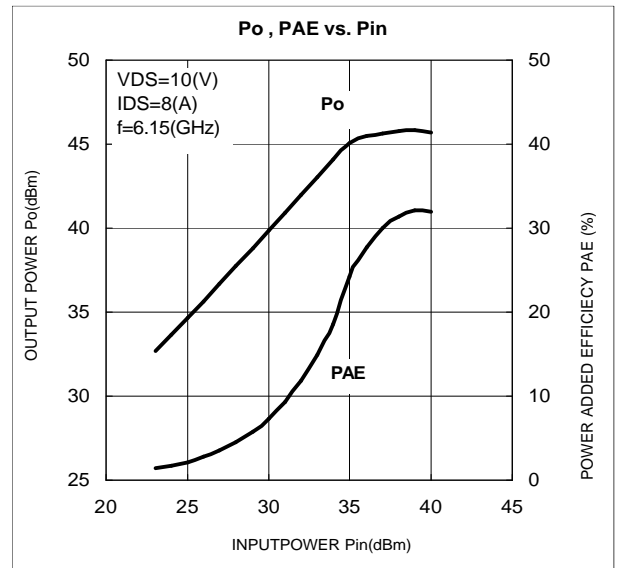
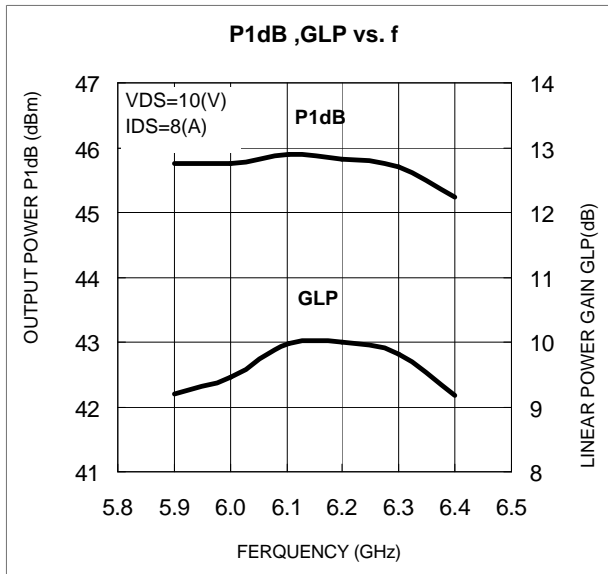
- (1) GATE
- (2) SOURCE(FIANGE)
- (3) DRAIN

< Keep safety first in your circuit designs! >

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5.9 - 6.4 GHz BAND 32W INTERNALLY MATCHED GaAs FET

TYPICAL CHARACTERISTICS (Ta=25 Deg.C)



S PARAMETERS (Ta=25 Deg.C , VDS=10V , IDS=8A)

f (GHz)	S Parameters (TYP.)							
	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)
5.90	0.61	159	2.957	-44	0.04	-117	0.21	160
6.00	0.55	138	3.071	-62	0.05	-134	0.22	134
6.10	0.48	115	3.119	-81	0.06	-152	0.25	112
6.20	0.41	92	3.148	-100	0.07	-167	0.26	91
6.30	0.34	65	3.143	-118	0.08	175	0.26	73
6.40	0.28	36	3.122	-137	0.09	160	0.25	55

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